

# Quality Publishing with IEEE

Qing Li

IEEE Client Services/University Partnership  
Program Manager

**IEEE** *Xplore*<sup>®</sup>  
DIGITAL LIBRARY

# About the IEEE

- World's largest technical membership association with over 430,000 members in over 160 countries
- Not for profit organization dedicated to "Advancing Technology For Humanity"
- Four core areas of activity
  - Membership organization
  - Conferences organizer
  - Standards developer
  - Leading publisher





## What we do

- Publish the top-cited science and technology research in the field, most notably our journals, conferences and standards
  - Publish 180 journals, transactions, and magazines
  - Sponsor more than 1,400 annual conferences worldwide
  - Leading developer of over 5,100 industry standards in a broad range of technologies
  - Over 4 million documents in the IEEE *Xplore* Digital Library, with more than 8 million downloads each month
  - Over 400 IEEE educational online learning courses, plus IEEE English for Engineering
  - Publish technical books in all the fields served by IEEE

# Full text content from all 39 IEEE Societies

**IEEE Aerospace and Electronic Systems Society**

**IEEE Antennas and Propagation Society**

**IEEE Broadcast Technology Society**

**IEEE Circuits and Systems Society**

**IEEE Communications Society**

**IEEE Components, Packaging, and Manufacturing Technology Society**

**IEEE Computational Intelligence Society**

**IEEE Computer Society**

**IEEE Consumer Electronics Society**

**IEEE Control Systems Society**

**IEEE Dielectrics and Electrical Insulation Society**

**IEEE Education Society**

**IEEE Electron Devices Society**

**IEEE Electromagnetic Compatibility Society**

**IEEE Engineering in Medicine and Biology Society**

**IEEE Geoscience and Remote Sensing Society**

**IEEE Industrial Electronics Society**

**IEEE Industry Applications Society**

**IEEE Information Theory Society**

**IEEE Instrumentation and Measurement Society**

**IEEE Intelligent Transportation Systems Society**

**IEEE Magnetics Society**

**IEEE Microwave Theory and Techniques Society**

**IEEE Nuclear and Plasma Sciences Society**

**IEEE Oceanic Engineering Society**

**IEEE Photonics Society**

**IEEE Power Electronics Society**

**IEEE Power & Energy Society**

**IEEE Product Safety Engineering Society**

**IEEE Professional Communications Society**

**IEEE Reliability Society**

**IEEE Robotics and Automation Society**

**IEEE Signal Processing Society**

**IEEE Society on Social Implications of Technology**

**IEEE Solid-State Circuits Society**

**IEEE Systems, Man, and Cybernetics Society**

**IEEE Technology and Engineering Management Society NEW in 2015**

**IEEE Ultrasonics, Ferroelectrics, and Frequency Control Society**

**IEEE Vehicular Technology Society**

**IEEE quality  
makes an impact**

# IEEE quality makes an impact

Thomson Reuters Journal Citation Reports® by Impact Factor

## IEEE publishes:

**17 of the top 20** journals in Electrical and Electronic Engineering

**14 of the top 15** journals in Telecommunications

**3 of the top 5** journals in Computer Science, Hardware & Architecture

**3 of the top 5** journals in Computer Science, Cybernetics

**3 of the top 5** journals in Automation & Control Systems

**3 of the top 5** journals in Artificial Intelligence

**2 of the top 5** journals in Imaging Science & Photographic Technology

The Thomson Reuters Journal Citation Reports presents quantifiable statistical data that provides a systematic, objective way to evaluate the world's leading journals.

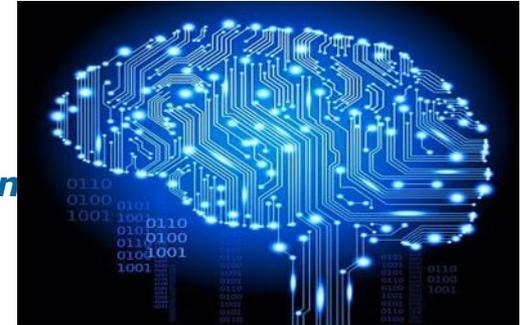
Based on the 2015 study released June 2016

More info: [www.ieee.org/citations](http://www.ieee.org/citations)

# New IEEE Journals Planned for 2017

In 2017, IEEE will introduce six new journals that will be available for subscription:

- *IEEE Communications Standards Magazine*
- *IEEE Journal of **Electromagnetics, RF and Microwaves in Medicine and Biology***
- *IEEE Transactions on **Emerging Topics in Computational Intelligence***
- *IEEE Transactions on **Green Communications and Networking***
- *IEEE Transactions on **Radiation and Plasma Medical Sciences***
- *IEEE Journal of **Radio Frequency Identification***



All Included in an IEL Subscription

For a complete title listing, to go: <http://ieeexplore.ieee.org/xpl/opacjrn.jsp>

# New IEEE Journals Coming in 2016

In 2016, IEEE will introduce four new journals that will be available for subscription:

- ▣ *IEEE Transactions on **Intelligent Vehicles***
- ▣ *IEEE Journal on **Multiscale and Multiphysics Computational Techniques***
- ▣ *IEEE **Robotics and Automation Letters***
- ▣ *IEEE Transactions on **Sustainable Computing***



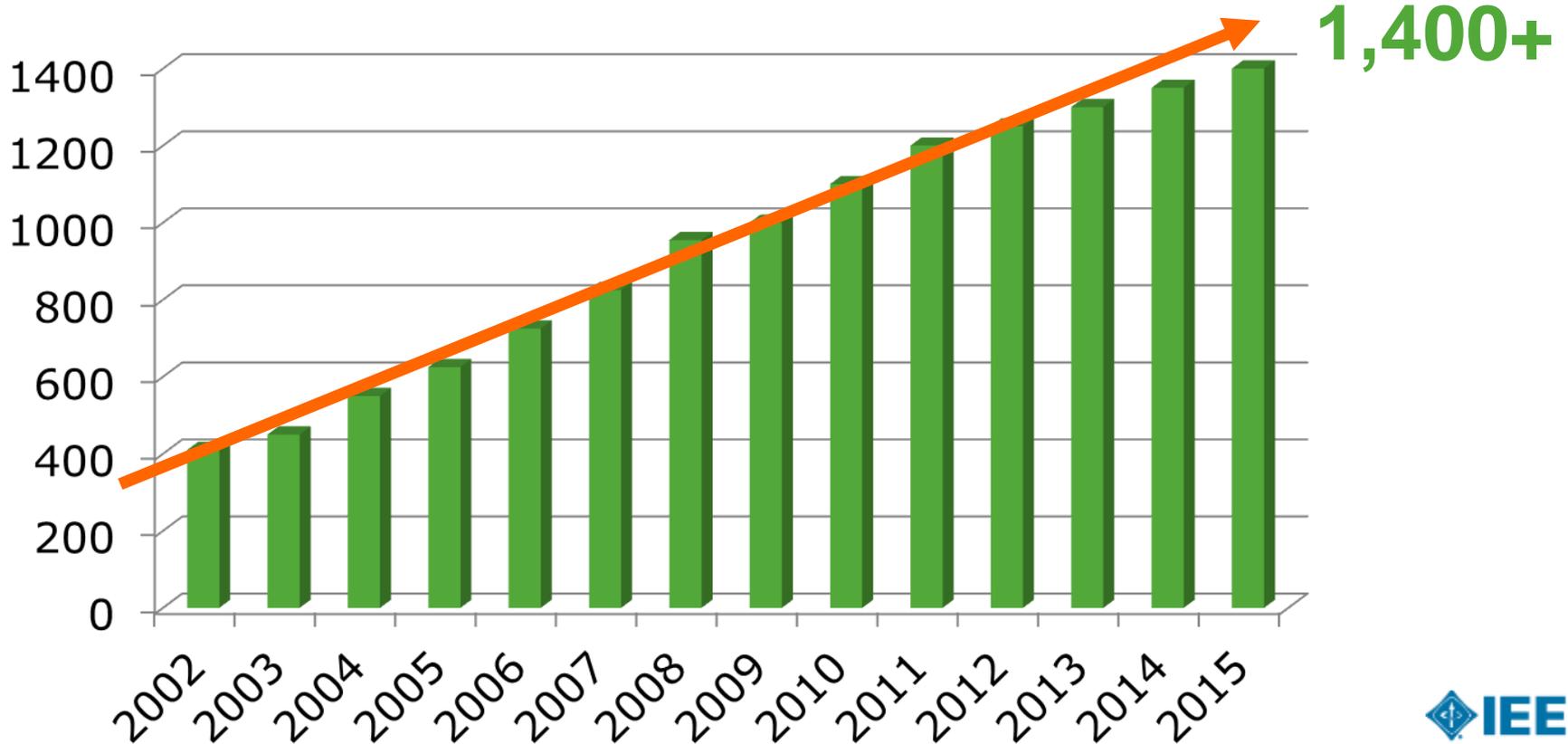
All included in an IEL subscription

For a complete title listing, to go: <http://ieeexplore.ieee.org/xpl/opacjrn.jsp>

# The IEEE conference collection continues to grow



Now over 1,400 annual conferences.  
Over 1.5 million total papers.



# Topics Covered

1. **Publishing choices**
2. **Paper Structure**
3. **Peer Review-Do vs. Don't**
4. **Author Tools**

# Choices

## Publish

# IEEE journal or IEEE conference?

- A **journal article** is a fully developed presentation of your work and its final findings
  - Original research results presented
  - Clear conclusions are made and supported by the data
- A **conference article** can be written while research is ongoing
  - Can present preliminary results or highlight recent work
  - Gain informal feedback to use in your research
- Conference articles are typically shorter than journal articles, with less detail and fewer references

# Publish IEEE journal or IEEE conference?

## IEEE Journals



- IEEE journals are cited 3 times more often in patent applications than other leading publisher's journals



- A high percentage of articles submitted to any professional publication are rejected

## IEEE Conferences

- IEEE Conference proceedings are recognized worldwide as the most vital collection of consolidated published articles in EE, computer science, related fields
- Per IEEE Policy, if you do not present your article at a conference, it may be suppressed in IEEE *Xplore* and not indexed in other databases

# PUBLICATIONS

ELECTRIFICATION MAGAZINE >

PES AUTHOR'S KIT >

PES TRANSACTIONS & JOURNALS ✓

Power And Energy Technology  
Systems Journal

Transactions On Energy Conversion

Transactions On Power Delivery

Transactions On Power Systems

Transactions On Smart Grid

Transactions On Sustainable  
Energy

Transaction Paper Abstracts

POWER & ENERGY MAGAZINE >

ENEWS UPDATE >

## Transactions and Journals

PES sponsors or co-sponsors six peer-reviewed technical journals. Only the highest-quality papers are considered for publication. As such, the acceptance rates are generally between 10 and 15 percent. Authors should consider this high standard for quality before submitting their manuscripts.

### Open Access

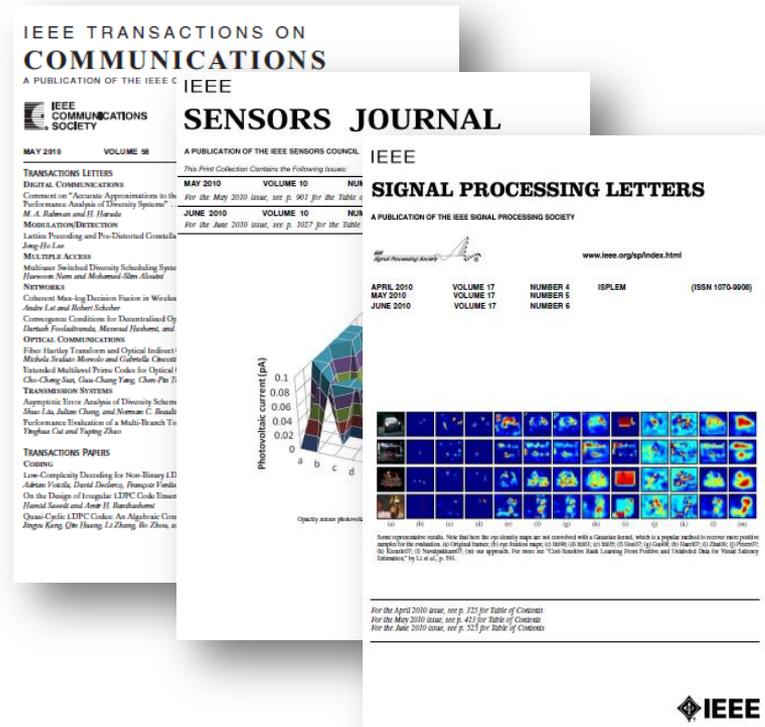
The *IEEE Transactions on Energy Conversion*, *IEEE Transactions on Power Delivery*, *IEEE Transactions on Power Systems*, *IEEE Transactions on Smart Grid*, and *IEEE Transactions on Sustainable Energy* are hybrid journals, allowing either Traditional manuscript submission or Open Access (author-pays OA) manuscript submission.

- The OA option, if selected, enables unrestricted public access to the article via IEEE Xplore. The OA option will be offered to the author at the time the manuscript is submitted. If selected, the OA discounted fee of \$1,750 must be paid before the article is published in the journal. If you have unusual circumstances about this, please contact the Editor-in-Chief. Any other applicable charges (such as the over-length page charge and/or charge for the use of color in the print format) will be billed separately once the manuscript formatting is complete but prior to publication.
- The traditional option, if selected, enables access to all qualified subscribers and purchasers via IEEE Xplore. No OA payment is required.

The *IEEE Power and Energy Technology Systems Journal* is an Open Access only publication. Open Access (OA) allows unrestricted public access to the article via IEEE Xplore. In lieu of paid subscriptions, authors are required to pay a publication fee after their paper has been accepted (\$1,350 per manuscript up to a maximum of 8 published pages; \$120 per

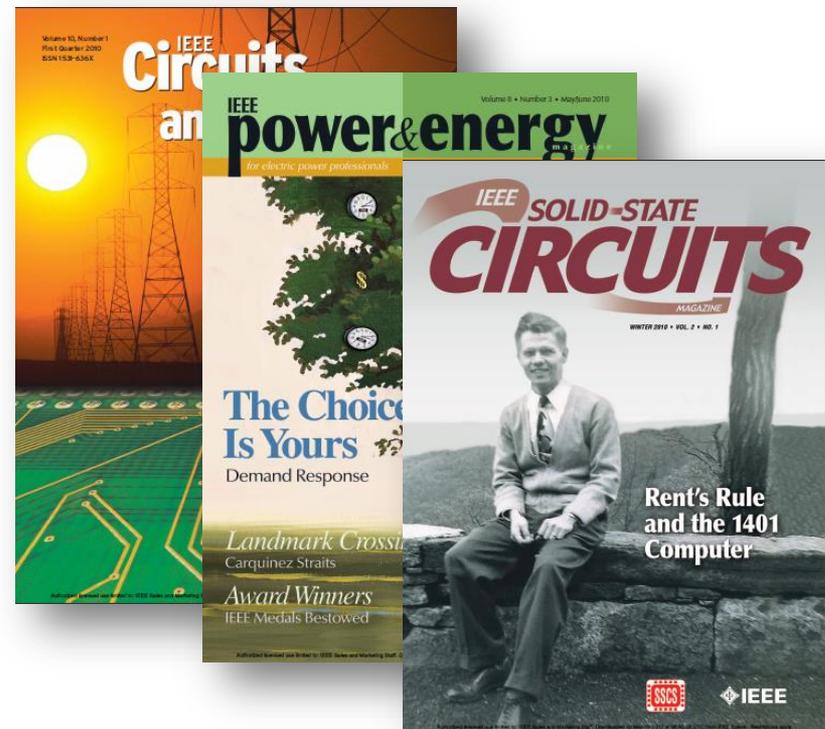
# Journals

- Journals, Transactions, and Letters are the primary means for publishing technical papers concerning original work in IEEE fields of interest.
  - The primary purpose of Journals, Transactions, and Letters is to disclose and provide a permanent archival record of original technical work that advances the state of the art or provides novel insights.
  - Letters are for the publication of brief papers, usually three to four pages in length.



# Magazines

- Magazines are characterized by regular and continuing issues with significant technical content in addition to general news and regular columns
  - IEEE Communications Magazine
  - IEEE Microwave Magazine
  - IEEE Signal Processing Magazine
  - IEEE Instrumentation & Measurement Magazine
  - .....



# IEEE Publication Recommender™

## IEEE Publication Recommender™

*Find the best match for your scholarly article*

- Search 170+ periodicals and 1500+ conferences
- Compare critical points such as Impact Factor and Submission-To-Publication Time
- Get all the key data about IEEE publications at a glance
- Download the results of your search



### Choose a search type and let Publication Recommender do the work!

- Both Periodicals and Conferences
- Periodicals only
- Conferences only

Enter keywords, key phrases, or article title

Extract keywords from your article

Enter your abstract here or upload your article file (PDF, DOC, DOCX, TEX).

+ ADD YOUR FILE

**Narrow by date:**  
(Optional)

I would like to publish before:

Get Recommendation

### Or, find details for a specific periodical or conference:

Enter the name of a periodical or conference

<http://publication-recommender.ieee.org/home>

▼ **Periodicals:** (166 results) Sort By:

Title	Open Access	Impact Factor	Submission to Publication Time in Xplore
<a href="#">Cloud Computing, IEEE</a>	No	Not yet available	Not yet available
<a href="#">Cloud Computing, IEEE Transactions on</a>	No	Not yet available	41.9 Weeks

▼ **Periodicals:** (166 results) Sort By:

Title	Open Access	Impact Factor	Submission to Publication Time in Xplore
<a href="#">Network and Service Management, IEEE Transactions on</a>	Yes	Not yet available	29.7 Weeks
<a href="#">Wireless Communications, IEEE</a>	No	5.417	Not yet available
<a href="#">Emerging Topics in Computing, IEEE Transactions on</a>	Yes	Not yet available	31.4 Weeks
<a href="#">Dependable and Secure Computing, IEEE Transactions on</a>	Yes	1.351	45.3 Weeks
<a href="#">Parallel and Distributed Systems, IEEE Transactions on</a>	Yes	2.17	33.2 Weeks

▼ **Conferences:** (37 results) Sort By:

Title   Location	Country	Abstract Submission Deadline	Conference Date
<a href="#">OCEANS 2018 MTS/IEEE Charleston</a> Location: Charleston Convention Center, 5001 Coliseum Drive , Charleston, SC, USA	USA	28 Jun 2018	20-26 Oct 2018
<a href="#">2018 IEEE Rural Electric Power Conference (REPC)</a> Location: Renaissance Hotel Oklahoma City Convention Center, Hotel and Spa, 10 N. Broadway, Oklahoma City, OK, USA	USA	15 Sep 2017	06-09 May 2018
<a href="#">2019 IEEE/MTT-S International Microwave Symposium - MTT 2019</a> Location: Boston Convention and Exhibition Center, Boston, MA, USA	USA	01 Dec 2018	02-07 Jun 2019

# Finding Conference Calls for Papers

## IEEE Conference Search Results

### Search Conferences

Select type & date range

Conference date  
 Call for papers

From:   
To:

**Location (optional)**

Select an IEEE region

Select a country/region

- Select a country/region
- Afghanistan
- Albania
- Algeria
- Andorra
- Angola
- Anguilla
- Antigua and Barbuda
- Argentina
- Armenia
- Aruba
- Australia**
- Austria
- Azerbaijan
- Bahamas
- Bahrain
- Bangladesh
- Barbados
- Belarus
- Belgium

**Your search returned 907 Conferences for electron devices**

Conference Name ▲ ▼	Conference Date ▲ ▼	Location ▲ ▼
<a href="#">2021 IEEE International Electron Devices Meeting (IEDM)</a> Abstract submission deadline: 01 Jun 2021 Final submission deadline: 01 Sep 2021 Notification of acceptance date: 01 Aug 2021	13 Dec - 15 Dec 2021	Hilton San Francisco Union Square San Francisco, CA, USA
<a href="#">2020 IEEE International Electron Devices Meeting (IEDM)</a>	10 Dec - 18 Dec 2020	Hilton San Francisco San Francisco, CA, USA
<a href="#">2020 IEEE Symposium on VLSI Technology</a>	16 Jun - 18 Jun 2020	TBD TBD, TBD,
<a href="#">2019 IEEE International Electron Devices Meeting (IEDM)</a> Abstract submission deadline: 01 Jun 2019 Final submission deadline: 01 Sep 2019 Notification of acceptance date: 01 Aug 2019	09 Dec - 11 Dec 2019	Hilton San Francisco Union Square San Francisco, CA, USA
<a href="#">2018 IEEE International Electron Devices Meeting (IEDM)</a>	29 Nov - 07 Dec 2018	Hilton San Francisco San Francisco, CA, USA
<a href="#">2018 IEEE Symposium on VLSI Technology</a>	12 Jun - 14 Jun 2018	TBD TBD, TBD,
<a href="#">2018 IEEE 30th International Symposium on Power Semiconductor Devices and IC's (ISPSD)</a> Abstract submission deadline: 31 Oct 2017 Full Paper Submission deadline: 31 Mar 2018	13 May - 17 May 2018	Palmer House Hilton 17 East Monroe Street Chicago, IL, USA

[http://www.ieee.org/conferences\\_events/index.html](http://www.ieee.org/conferences_events/index.html)

# Structure

# Paper Structure

## Elements of a manuscript

Title

Abstract

Keywords

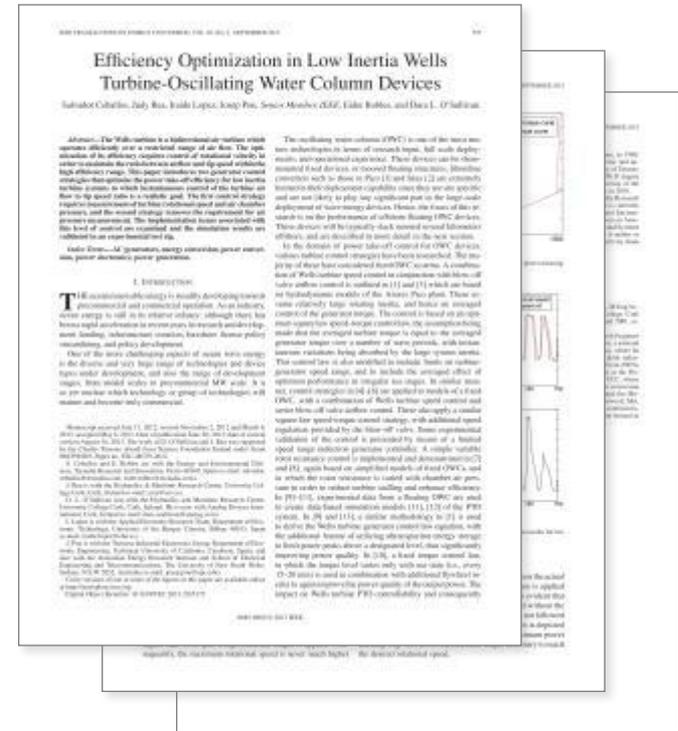
Introduction

Methodology

Results/Discussions/Findings

Conclusion

References



# Peer Review

# How does the review process work?

- Editor-in-Chief gets the paper after it goes through content match check (iAuthenticate) and “banned author” check
- If the paper is in scope for the journal, it is assigned to an editor (associate editor)
- Editor assigns the paper to five or more reviewers
- Reviewers send their comments back to the editor
- Editor makes a recommendation to the EIC as follows
  - Accept
  - Revise & Resubmit
  - Reject
- The EIC makes the final decision and informs the corresponding author

## Audience

# Why IEEE editors and reviewers reject papers

- The content is not a good fit for the publication
- There are serious scientific flaws:
  - Inconclusive results or incorrect interpretation
  - Fraudulent research
- It is poorly written
- It does not address a big enough problem or advance the scientific field
- The work was previously published
- The quality is not good enough for the journal
- Reviewers have misunderstood the article

## Ethics

# Ethical publishing

## Plagiarism

- Avoid plagiarism
  - Cite and separate any verbatim copied material – **but how much?**
  - Paraphrase other's text properly, and include citation
  - Credit any ideas from other sources
  - Familiarize yourself with IEEE Policies



**Refer to our Tips Sheet**  
[http://www.ieee.org/publications\\_standards/publications/authors/plagiarism\\_and\\_multiple\\_submissions.pdf](http://www.ieee.org/publications_standards/publications/authors/plagiarism_and_multiple_submissions.pdf)

Crosscheck!

<https://crosscheck.ieee.org/crosscheck/>

# Ethical publishing

### Duplication, Redundancies & Multiple Submissions

- Author must submit original work that:
  - Has not appeared elsewhere for publication
  - Is not under review for another refereed publication
  - Cites previous work
  - Indicates how it differs from the previously published work
  - Authors **MUST** also **inform the editor** when submitting any previously published work



**Refer to our Tips Sheet**  
[http://www.ieee.org/publications\\_standards/publications/authors/plagiarism\\_and\\_multiple\\_submissions.pdf](http://www.ieee.org/publications_standards/publications/authors/plagiarism_and_multiple_submissions.pdf)

# Author Tools

# Locate and Use IEEE Author Tools

[http://www.ieee.org/publications\\_standards/publications/authors/authors\\_journals.html](http://www.ieee.org/publications_standards/publications/authors/authors_journals.html)



IEEE offers a suite of tools to help authors prepare their manuscript and find the right publication outlet.

Our package of tools is unique among scholarly publishers.



# First, identify yourself with ORCID

ORCID is a unique, persistent identifier for authors that helps them:

- Ensure work is discoverable and connected to them throughout career (including moves and name changes)
- Minimize time spent entering repetitive information for manuscript submissions and grant applications
- Eliminate name ambiguity and ensure proper attribution
  - More info at [orcid.org](http://orcid.org)

IEEE now requires ORCIDs for all corresponding authors (effective July 2016)

ORCID

# Author Tool: Article Templates

> REPLACE THIS LINE WITH YOUR PAPER IDENTIFICATION NUMBER (DOUBLE-CLICK HERE TO EDIT) < 1

## Preparation of Papers for IEEE TRANSACTIONS and JOURNALS (December 2013)

First A. Author, *Fellow, IEEE*, Second B. Author, and Third C. Author, Jr., *Member, IEEE*

**Abstract**—These instructions give you guidelines for preparing papers for IEEE Transactions and Journals. Use this document as a template if you are using Microsoft Word 6.0 or later. Otherwise, use this document as an instruction set. The electronic file of your paper will be formatted further at IEEE. Paper titles should be written in uppercase and lowercase letters, not all uppercase. Avoid writing long formulas with subscripts in the title; short formulas that identify the elements are fine (e.g., "Nd-Fe-B"). Do not write "(Invited)" in the title. Full names of authors are preferred in the author field, but are not required. Put a space between authors' initials. Define all symbols used in the abstract. Do not cite references in the abstract. Do not delete the blank line immediately above the abstract, it sets the footnote at the bottom of this column.

**Index Terms**—Enter key words or phrases in alphabetical order, separated by commas. For a list of suggested keywords, send a blank e-mail to [keywords@ieee.org](mailto:keywords@ieee.org) or visit [http://www.ieee.org/organizations/pubs/ami\\_prod/keyword98.txt](http://www.ieee.org/organizations/pubs/ami_prod/keyword98.txt)

### I. INTRODUCTION

THIS document is a template for Microsoft Word versions 6.0 or later. If you are reading a paper or PDF version of this document, please download the electronic file, TRANS-JOUR.DOC, from the IEEE Web site at <http://www.ieee.org/web/publications/authors/transjnl/index.html>.<sup>30</sup> you can use it to prepare your manuscript. If you would prefer to use LATEX, download IEEE's LATEX style and sample files from the same Web page. Use these LATEX files for formatting, but please follow the instructions in TRANS-JOUR.DOC or TRANS-JOUR.PDF.

If your paper is intended for a conference, please contact your conference editor concerning acceptable word processor formats for your particular conference.

This paragraph of the first footnote will contain the date on which you submitted your paper for review. It will also contain support information, including sponsor and financial support acknowledgment. For example, "This work was supported in part by the U.S. Department of Commerce under Grant BS123456".

The next few paragraphs should contain the authors' current affiliations, including current address and e-mail. For example, F. A. Author is with the National Institute of Standards and Technology, Boulder, CO 80505 USA (e-mail: [author@boulder.nist.gov](mailto:author@boulder.nist.gov)).

S. B. Author, Jr. was with Rice University, Houston, TX 77005 USA. He is now with the Department of Physics, Colorado State University, Fort Collins, CO 80523 USA (e-mail: [author@lamar.colostate.edu](mailto:author@lamar.colostate.edu)).

T. C. Author is with the Electrical Engineering Department, University of Colorado, Boulder, CO 80509 USA, on leave from the National Research Institute for Metals, Tsukuba, Japan (e-mail: [author@nim.go.jp](mailto:author@nim.go.jp)).

### II. GUIDELINES FOR MANUSCRIPT PREPARATION

When you open TRANS-JOUR.DOC, select "Page Layout" from the "View" menu in the menu bar (View | Page Layout), (these instructions assume MS 6.0. Some versions may have alternate ways to access the same functionalities noted here). Then, type over sections of TRANS-JOUR.DOC or cut and paste from another document and use markup styles. The pull-down style menu is at the left of the Formatting Toolbar at the top of your Word window (for example, the style at this point in the document is "Text"). Highlight a section that you want to designate with a certain style, then select the appropriate name on the style menu. The style will adjust your fonts and line spacing. Do not change the font sizes or line spacing to squeeze more text into a limited number of pages. Use italics for emphasis; do not underline.

To insert images in Word, position the cursor at the insertion point and either use Insert | Picture | From File or copy the image to the Windows clipboard and then Edit | Paste Special | Picture (with "float over text" unchecked).

IEEE will do the final formatting of your paper. If your paper is intended for a conference, please observe the conference page limits.

#### A. Abbreviations and Acronyms

Define abbreviations and acronyms the first time they are used in the text, even after they have already been defined in the abstract. Abbreviations such as IEEE, SI, ac, and dc do not have to be defined. Abbreviations that incorporate periods should not have spaces: write "C.N.R.S.," not "C. N. R. S.," Do not use abbreviations in the title unless they are unavoidable (for example, "IEEE" in the title of this article).

#### B. Other Recommendations

Use one space after periods and colons. Hyphenate complex modifiers: "zero-field-cooled magnetization." Avoid dangling participles, such as, "Using (1), the potential was calculated." [It is not clear who or what used (1).] Write instead, "The potential was calculated by using (1)," or "Using (1), we calculated the potential."

Use a zero before decimal points: "0.25," not ".25." Use "cm<sup>3</sup>," not "cc." Indicate sample dimensions as "0.1 cm × 0.2 cm," not "0.1 × 0.2 cm<sup>2</sup>." The abbreviation for "seconds" is "s," not "sec." Use "W/m<sup>2</sup>" or "watts per square meter," not "watts/m<sup>2</sup>." When expressing a range of values, write "7 to 9" or "7-9," not "7-9."

# Author Tool: Reference Preparation Assistant

IEEE Author  
DIGITAL TOOLS

## IEEE Reference Preparation Assistant



Administration

Help Login

The IEEE Reference Preparation Assistant is an automated tool for use by authors to validate references against both the IEEE Xplore and CrossRef databases in order to ensure successful on-line linking. This tool should be used before submitting an article to IEEE. Please log in to begin.

### Enter your details to log in

All information is required

First name

Last name

Email  
address

CONTINUE

<http://refassist.ieee.org/action/showAuthorLogin>



# Author Tool: PDF Checker

## IEEE PDF Checker

---

### Upload File

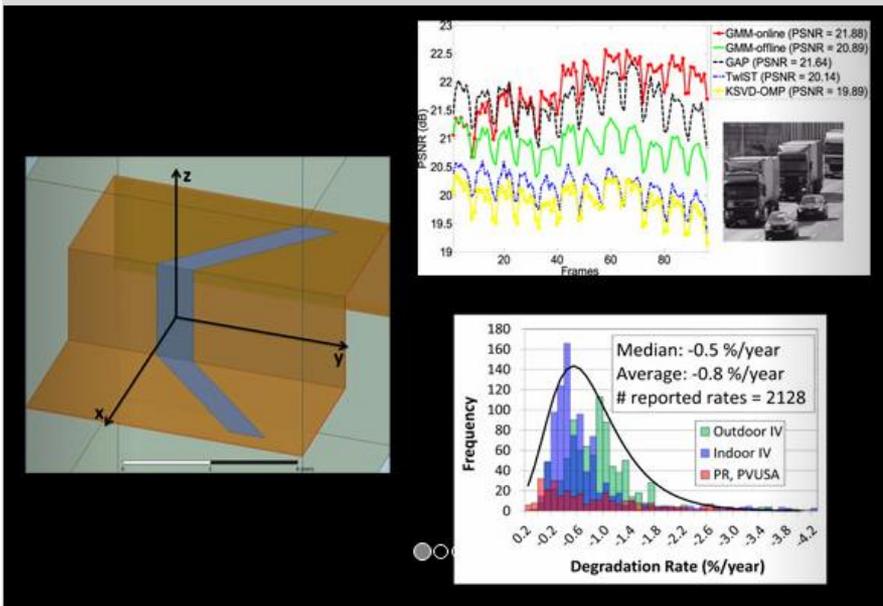
Paper Title:

IEEE Publication Title: Aerospace & Electronics Systems Magazine, IEEE ▼

File:

[http://www.ieee.org/publications\\_standards/publications/authors/pdf\\_checker.html](http://www.ieee.org/publications_standards/publications/authors/pdf_checker.html)

# Author Tool: Graphics Analyzer



## HOW THE IEEE GRAPHICS ANALYZER WORKS

STEP 1



Select and upload



STEP 2



Wait for report



STEP 3



Get notified

## ANALYZE YOUR GRAPHICS FILES

Speed up your scholarly publishing process by checking your graphics files prior to submission. [Learn more.](#)

<http://graphicsqc.ieee.org/>

# Use AuthorLab in IEEE Collabratec for additional support and help



## IEEE AuthorLab

Hide D

The IEEE AuthorLab welcomes all IEEE authors and potential authors to this forum on publishing in IEEE periodicals. Participate in discussions about publishing, and ask questions of other community members, or IEEE publication staff.

Community provided by :  
IEEE Publications

Participants 4336



All Participants

June 2016 ▶

Su	Mo	Tu	We	Th	Fr	Sa
			1	2	3	4

Post Question File

Post to your Community (max 4000 characters)

4000 characters remaining

Promote This Post (Manage)

Post

Activities Files Q & A Events Participants

263 Post(s) in Community Q



**Tiffany Mckerahan** posted Share Down Arrow

a day ago

Don't miss IEEE's author education event at the 2016 IEEE International Geoscience and Remote Sensing Symposium (IGARSS) conference in Beijing next month! Check out [ieee.org/publications\\_s..](http://ieee.org/publications_s..) for other author education events.

# Submit

# Journal paper submission is easy through *IEEE Xplore*®

Click "Submit a Manuscript"

Browse Journals & Magazines > Power Electronics, IEEE Transa ...

## Power Electronics, IEEE Transactions on

Popular Early Access Current Issue Past Issues About Journal **Submit Your Manuscript**

IEEE Transactions on Power Electronics covers fundamental technologies used in the control and conversion of electric power.  
[Aims & Scope >](#)

4.08 Impact Factor	0.0264 Eigenfactor	0.961 Article Influence Score
-----------------------	-----------------------	----------------------------------

Follow the prompts to set up an account

IEEE | IEEE Transactions on Power Electronics | Log In | Create Account | [Get Help Now](#)

### SCHOLARONE™ Manuscripts

Login

Log In

Welcome to the *IEEE Transactions on Power Electronics*. Please enter your User ID and Password into the boxes below. If you do not have an account, or have forgotten your password, click on the "Password Help" section below. If you have any questions, please contact your librarian.

**Log In**

Log in here if you are already a registered user.

User ID:

Password:  [Log In](#)

**IEEE POWER ELECTRONICS SOCIETY**  
Powering a Sustainable Future

**Password Help.** Enter your e-mail address to receive an e-mail with your account information.

E-Mail Address:  [Go](#)

**New User?**

[Register here](#)

**Resources**

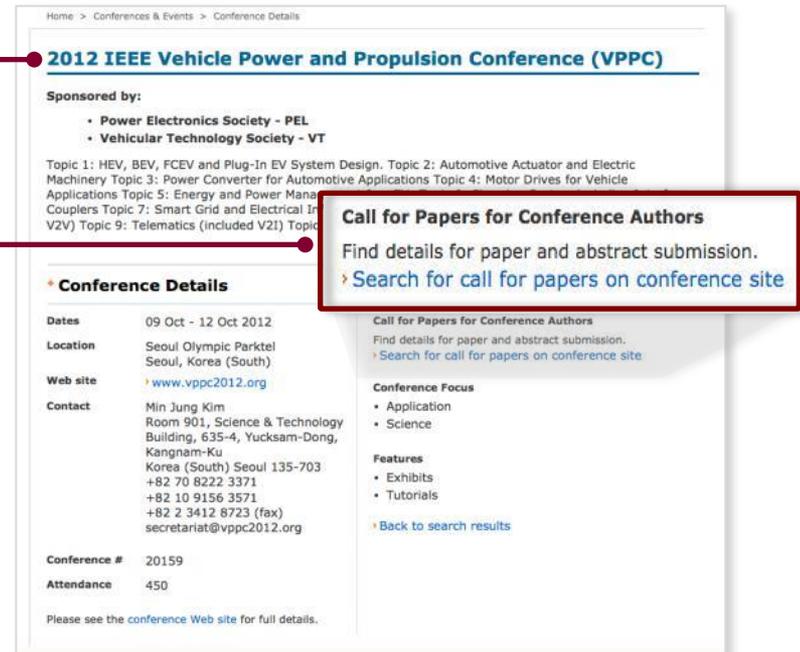
- [Instructions & Forms](#)
- [User Tutorials](#)
- [System Requirements](#)
- [Home Page](#)

## Submit

# Use conference site (not IEEE Xplore) to submit to a conference

For complete information, see the Call for Papers for the conference in question.

Each IEEE sponsored conference has its own requirements for publishing.



Home > Conferences & Events > Conference Details

### 2012 IEEE Vehicle Power and Propulsion Conference (VPPC)

**Sponsored by:**

- Power Electronics Society - PEL
- Vehicular Technology Society - VT

Topic 1: HEV, BEV, FCEV and Plug-In EV System Design. Topic 2: Automotive Actuator and Electric Machinery Topic 3: Power Converter for Automotive Applications Topic 4: Motor Drives for Vehicle Applications Topic 5: Energy and Power Management Topic 6: Power Electronics and Power Couplers Topic 7: Smart Grid and Electrical Infrastructure Topic 8: Power Quality and Power Electronics Topic 9: Telematics (included V2I) Topic 10: Power Electronics and Power Quality

**Conference Details**

<b>Dates</b>	09 Oct - 12 Oct 2012
<b>Location</b>	Seoul Olympic Parktel Seoul, Korea (South)
<b>Web site</b>	<a href="http://www.vppc2012.org">www.vppc2012.org</a>
<b>Contact</b>	Min Jung Kim Room 901, Science & Technology Building, 635-4, Yucksam-Dong, Kangnam-Ku Korea (South) Seoul 135-703 +82 70 8222 3371 +82 10 9156 3571 +82 2 3412 8723 (fax) secretariat@vppc2012.org
<b>Conference #</b>	20159
<b>Attendance</b>	450

Please see the [conference Web site](#) for full details.

**Call for Papers for Conference Authors**

Find details for paper and abstract submission.

[Search for call for papers on conference site](#)

**Conference Focus**

- Application
- Science

**Features**

- Exhibits
- Tutorials

[Back to search results](#)

# Throughout the process...Refer here early and often – IEEE Author Digital Tools

## Author Digital Tools

### ♦ IEEE Publications Menu

[Publications Home](#)

[Publications News](#)

### + Publication Types

### + Publishing Tools & Services

### + Reprints, Rights & Permissions

[Advertising in IEEE Publications](#)

### + Publications Board

### + Author Resources

[Contact IEEE Publishing](#)

[Author FAQs](#)

## IEEE Author DIGITAL TOOLS

Below are information and tools to assist with all stages of publishing with IEEE.

### On this page:

- › [Preparing your article](#)
- › [Preparing your graphics and multimedia materials](#)
- › [Guidelines for article submission](#)
- › [Post-acceptance procedures](#)
- › [Post-publication procedures](#)
- › [Frequently asked questions](#)

### ♦ Preparing your article

#### › [IEEE Publishing Policy](#) (PDF, 46 KB)

Important information for authors interested in publishing in IEEE Transactions, Journals, and Letters.

#### › [Register for an ORCID](#)

Register for the persistent digital identifier that distinguishes you from every other researcher.

#### › [Overleaf Collaborative Authoring](#)

IEEE has partnered with Overleaf to allow authors to collaborate, write articles, and share files.

#### › [IEEE Style Manual](#) (PDF, 574 KB)

Editorial guidelines for IEEE Transactions, Journals, and Letters.

#### › [Keywords Suggested for Authors](#) (PDF, 326 KB)

Authors are encouraged to select keywords from this list. It comprises the first three hierarchical "levels" under each term-family (or branch) that is formed from the top-most terms of the IEEE Thesaurus. If you cannot find appropriate terms, you may add your own.

#### › [Article Templates](#)

Includes templates and instructions on how to prepare your papers for publication in IEEE Transactions and Journals.

### Authorship

- › [Learn the benefits of publishing with IEEE](#)
- › [View authorship workshop video for writing technical papers](#)
- › [IEEE Publication Recommender](#)

### IEEE Open Access

IEEE Open Access delivers articles free of charge to readers worldwide.

- › [Learn about IEEE Open Access](#)

### More Useful Links

#### Article Templates

- › [Find appropriate templates for the publication you intend to publish in](#)

#### Author Copyright Help

- › [IEEE Rights & Permissions Department](#)
- › [Download IEEE Copyright Form](#) (PDF, 108 KB)

#### Contact IEEE Transactions, Journals and Letters

For general inquires or to request further information, email [trans@ieee.org](mailto:trans@ieee.org)

For inquiries specific to graphics, email [graphics@ieee.org](mailto:graphics@ieee.org)

# IEEE Author Guide Always Available

- Authors learn how to prepare, write, and submit quality technical articles
- Can be downloaded
- Includes embedded links to information, forms, etc.

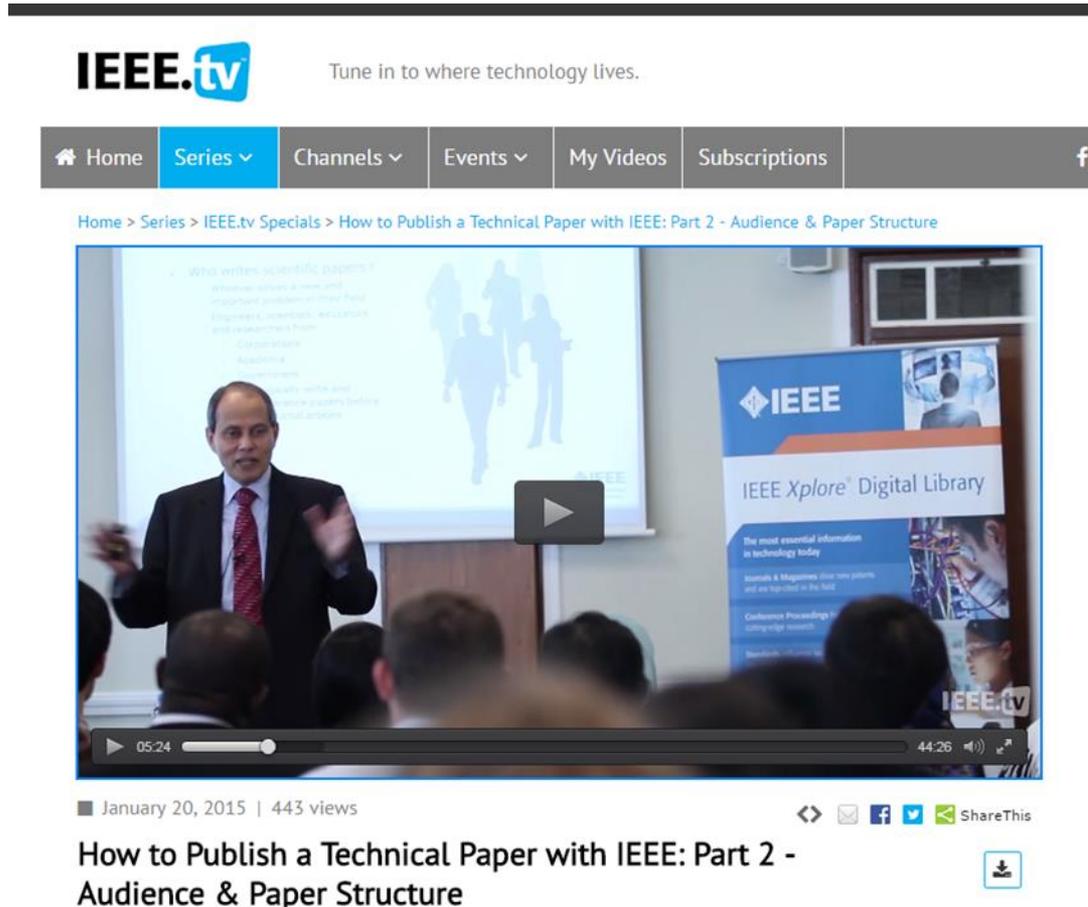


For more information or to download: [http://www.ieee.org/publications\\_standards/publications/authors/publishing\\_benefits/index.html?WT.mc\\_id=pb\\_ben\\_pub](http://www.ieee.org/publications_standards/publications/authors/publishing_benefits/index.html?WT.mc_id=pb_ben_pub)

# Free Authorship videos on IEEE.tv

Speaker: Professor Saifur Rahman from Virginia Tech (VP of Pubs for IEEE's Power & Energy Society)

<http://innovate.ieee.org/innovate/industry/academic/whats-new/newcontent/article/80448>



The screenshot displays the IEEE.tv website interface. At the top, the IEEE.tv logo is on the left, and the tagline 'Tune in to where technology lives.' is on the right. Below the logo is a navigation menu with 'Home', 'Series', 'Channels', 'Events', 'My Videos', and 'Subscriptions'. The main content area shows a breadcrumb trail: 'Home > Series > IEEE.tv Specials > How to Publish a Technical Paper with IEEE: Part 2 - Audience & Paper Structure'. The video player shows a man in a suit presenting in front of a screen. The screen displays the text 'Who writes scientific papers?' and lists 'Who writes scientific papers?' as 'Who writes scientific papers? important problem in their field Engineers, scientists, educators and researchers from Academia Industry Government'. To the right of the video player is a banner for 'IEEE Xplore Digital Library' with the text 'The most essential information in technology today' and 'Articles & Magazines cover new papers and are indexed in the field'. Below the video player, the video title 'How to Publish a Technical Paper with IEEE: Part 2 - Audience & Paper Structure' is displayed, along with the date 'January 20, 2015' and '443 views'. There are also social media sharing icons and a download icon.

# Key sites to remember

**IEEE Author Tools:** [IEEE.org/go/authorship](http://IEEE.org/go/authorship)

**IEEE Conference Search and Calls for Papers:**  
[http://www.ieee.org/conferences\\_events/index.html](http://www.ieee.org/conferences_events/index.html)

**IEEE Xplore:** <http://ieeexplore.ieee.org>

**IEEE Xplore information, training and tools:**  
<http://www.ieee.org/go/clientservices>

**IEEE Journal Citation reports:** [www.ieee.org/citations](http://www.ieee.org/citations)

# Contacts for Author Questions

Abstract & Indexing services	<a href="mailto:discoveryservices@ieee.org">discoveryservices@ieee.org</a>
Copyright policies	<a href="mailto:copyrights@ieee.org">copyrights@ieee.org</a>
Permissions and reuse	<a href="mailto:pubs-permissions@ieee.org">pubs-permissions@ieee.org</a>
Posting articles in repositories	<a href="mailto:copyrights@ieee.org">copyrights@ieee.org</a>
Preparing figures	<a href="mailto:graphics@ieee.org">graphics@ieee.org</a>
Reprints	<a href="mailto:reprints@ieee.org">reprints@ieee.org</a>
Status report on article in production	Publication editor or <a href="mailto:trans@ieee.org">trans@ieee.org</a>
Subscriptions	<a href="mailto:customer-service@ieee.org">customer-service@ieee.org</a>

# Thank You

[li.q@ieee.org](mailto:li.q@ieee.org)